

Heisener.com

# MT29F32G08CBEDBL83A3WC1

### MT29F32G08CBEDBL83A3WC1 Information

Part Number MT29F32G08CBEDBL83A3WC1

Manufacturer Micron Technology Inc.

Category Integrated Circuits (ICs)

Memory

**Description** IC FLASH 32GBIT WAFER

Package Die

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com

Request a Quote



## **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









## MT29F32G08CBEDBL83A3WC1 Specifications

Manufacturer Part Number	MT29F32G08CBEDBL83A3WC1
Manufacturer	Micron Technology Inc.
Category	Integrated Circuits (ICs)
	Memory
Package	Die
Series	-
Memory Type	Non-Volatile
Memory Format	FLASH
Technology	FLASH - NAND
Memory Size	32Gb (4G x 8)
Memory Interface	Parallel
Clock Frequency	-
Write Cycle Time - Word, Page	-
Access Time	-
Voltage - Supply	2.7 V ~ 3.6 V
Operating Temperature	$0^{\circ}\text{C} \sim 70^{\circ}\text{C} \text{ (TA)}$
Mounting Type	Surface Mount
Package / Case	Die
Supplier Device Package	Die
	Report errors?

#### MT29F32G08CBEDBL83A3WC1 Guarantees



#### **Ouality Guarantees**

We provide 90 days warranty. \*

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

### MT29F32G08CBEDBL83A3WC1 Payment Methods



















## MT29F32G08CBEDBL83A3WC1 Shipping Methods













If you have any question about MT29F32G08CBEDBL83A3WC1, please do not hesitate to contact us!

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